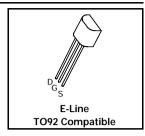
# N-CHANNEL ENHANCEMENT MODE VERTICAL DMOS FET

**ZVN3310A** 

#### ISSUE 2 - MARCH 94

#### **FEATURES**

- \* 100 Volt V<sub>DS</sub>
- \*  $R_{DS(on)} = 10\Omega$



#### ABSOLUTE MAXIMUM RATINGS.

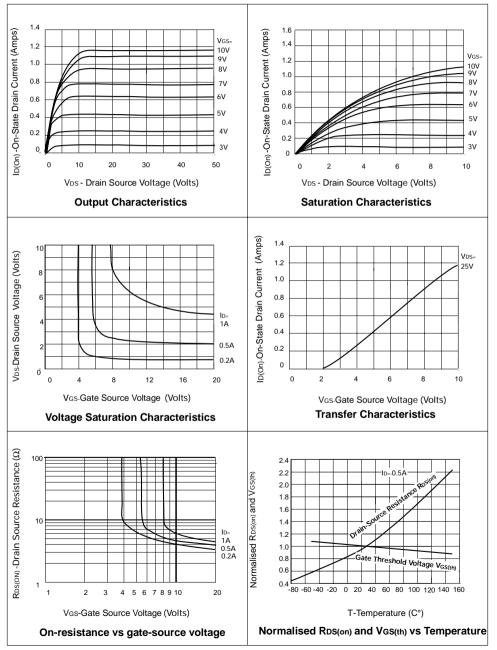
PARAMETER	SYMBOL	VALUE	UNIT
Drain-Source Voltage	V <sub>DS</sub>	100	V
Continuous Drain Current at T <sub>amb</sub> =25°C	I <sub>D</sub>	200	mA
Pulsed Drain Current	I <sub>DM</sub>	2	А
Gate-Source Voltage	$V_{GS}$	± 20	V
Power Dissipation at T <sub>amb</sub> =25°C	P <sub>tot</sub>	625	mW
Operating and Storage Temperature Range	T <sub>j</sub> :T <sub>stg</sub>	-55 to +150	°C

## ELECTRICAL CHARACTERISTICS (at T<sub>amb</sub> = 25°C unless otherwise stated).

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	CONDITIONS.	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100		V	$I_D=1$ mA, $V_{GS}=0$ V	
Gate-Source Threshold Voltage	$V_{GS(th)}$	0.8	2.4	V	ID=1mA, V <sub>DS</sub> = V <sub>GS</sub>	
Gate-Body Leakage	I <sub>GSS</sub>		20	nA	$V_{GS}$ =± 20V, $V_{DS}$ =0V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		1 50	μ <b>Α</b> μ <b>Α</b>	$V_{DS}$ =100V, $V_{GS}$ =0 $V_{DS}$ =80V, $V_{GS}$ =0V, T=125°C(2)	
On-State Drain Current(1)	I <sub>D(on)</sub>	500		mA	V <sub>DS</sub> =25V, V <sub>GS</sub> =10V	
Static Drain-Source On-State Resistance (1)	R <sub>DS(on)</sub>		10	Ω	V <sub>GS</sub> =10V,I <sub>D</sub> =500mA	
Forward Transconductance(1)(2	g <sub>fs</sub>	100		mS	V <sub>DS</sub> =25V,I <sub>D</sub> =500mA	
Input Capacitance (2)	C <sub>iss</sub>		40	pF	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz	
Common Source Output Capacitance (2)	C <sub>oss</sub>		15	pF		
Reverse Transfer Capacitance (2)	C <sub>rss</sub>		5	pF		
Turn-On Delay Time (2)(3)	t <sub>d(on)</sub>		5	ns	V <sub>DD</sub> ≈25V, I <sub>D</sub> =500mA	
Rise Time (2)(3)	t <sub>r</sub>		7	ns		
Turn-Off Delay Time (2)(3)	t <sub>d(off)</sub>		6	ns		
Fall Time (2)(3)	t <sub>f</sub>		7	ns		

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## TYPICAL CHARACTERISTICS



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## TYPICAL CHARACTERISTICS

